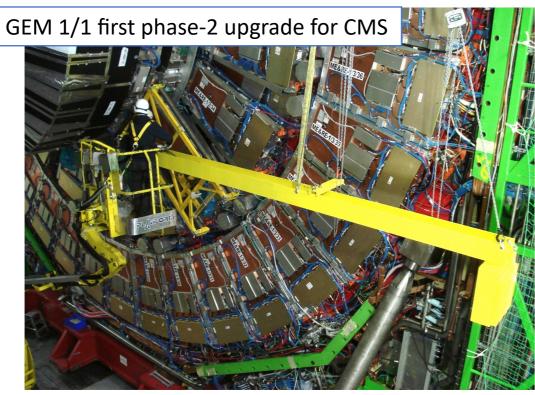




## Upgrades of ALICE, ATLAS, CMS and LHCb

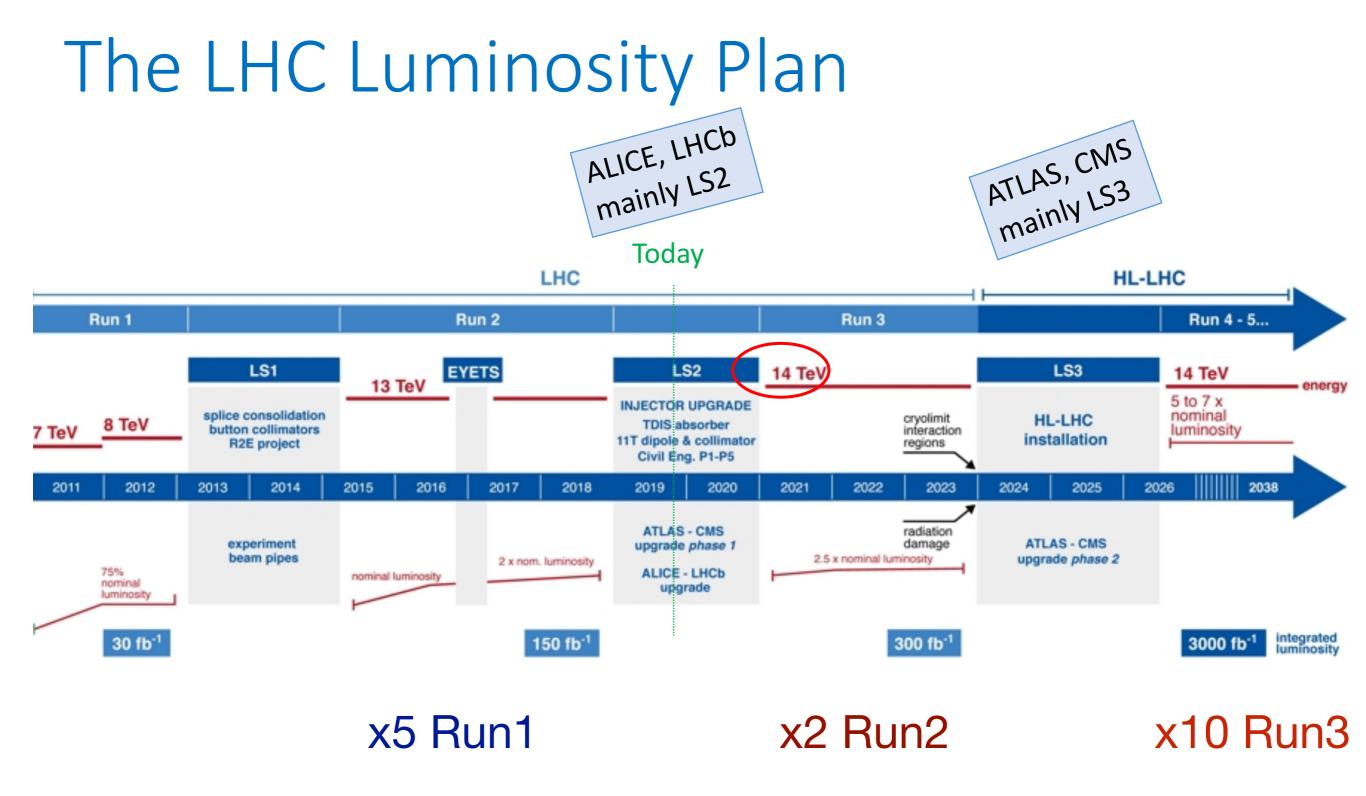


Frank Hartmann (ETP)





#### www.kit.edu



So far LHC has delivered 5% or less of the total planned integrated luminosity!

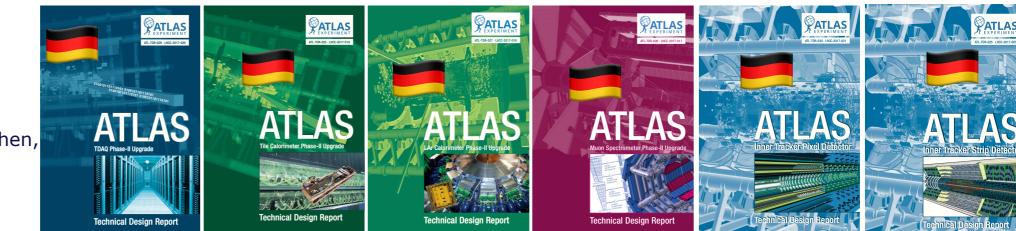
Stay alert: High level strategy meeting on HL-LHC schedule with CERN Management 27.11.2019



Berlin (HU), Bonn, Dortmund, Dresden, Freiburg, Gießen, Göttingen, Heidelberg,

Mainz, München (LMU), Siegen, Wuppertal, Würzburg, MPI für Physik München, DESY

HE MET





Technical Design Repor

RWTH Aachen, Universität Hamburg, Karlsruher Institut für Technologie, DESY

TU Dortmund,

**RWTH Aachen** 

Universität Heidelberg,

Universität Rostock

MPI für Kernphysik Heidelberg,

# On the technology aspect

## From our external reviewers:

"We want to note (again) that these projects are unprecedented in scale in particle physics, shift various paradigms, and employ technologies that have never before been exercised by the field."

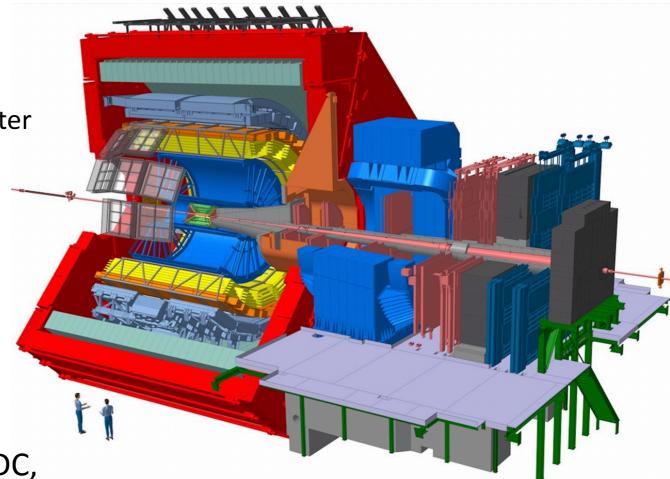
# ALICE Upgrade during LS2 and LS3

## LS2

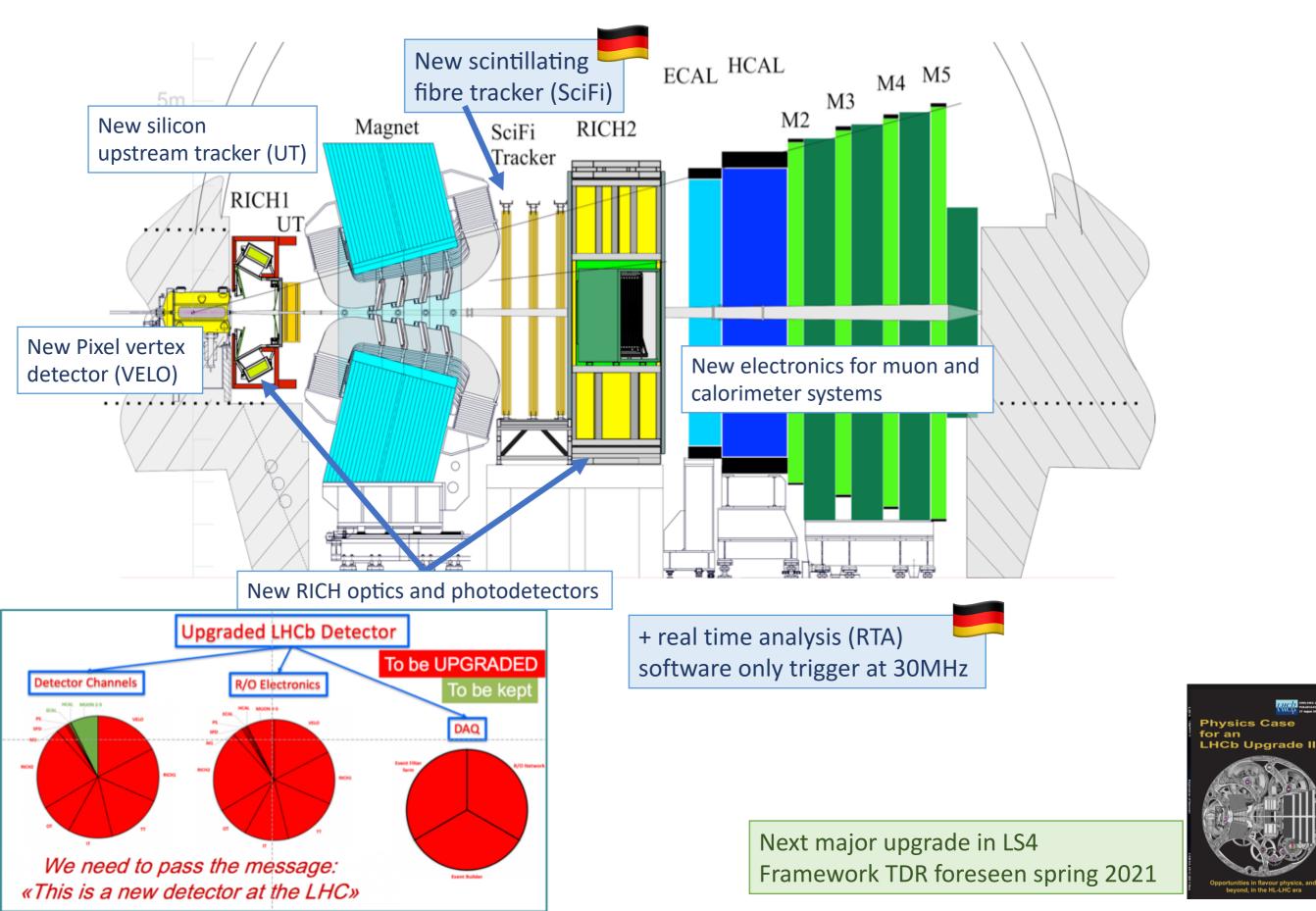
- New Inner Tracking System (ITS)
  - MAPS: improved resolution, less material, faster readout
- New Muon Forward Tracker (MFT)
  - vertex tracker at forward rapidity
- New TPC Readout Chambers
  - 4-GEM detectors  $\rightarrow$  continuous r/o
- New forward trigger detectors (FIT)
  - centrality, event plane
- **Upgraded** read-out for TOF, TRD, MUON, ZDC, EMCal, PHOS, new Online-Offline
  - record minimum-bias Pb-Pb data at 50 kHz (currently <1 kHz)</li>

## LS3

- A new ultra-light inner barrel ITS3
  - 3 truly cylindrical layers made of ~7x14 cm2 sensors thinned to 20-40 μm



# LHCB Upgrade new detector during LS2



# CMS HL-LHC Upgrade

### L1-Trigger/HLT/DAQ

https://cds.cern.ch/record/2283192 https://cds.cern.ch/record/2283193

- Tracks in L1-Trigger at 40 MHz
- PFlow-like selection 750 kHz output
- HLT output 7.5 kHz

#### **Barrel Calorimeters**

#### https://cds.cern.ch/record/2283187

- ECAL crystal granularity readout at 40 MHz with precise timing for  $e/\gamma$  at 30 GeV
- ECAL and HCAL new Back-End boards

### Muon systems 📒

https://cds.cern.ch/record/2283189

- DT & CSC new FE/BE readout
- RPC back-end electronics
- New GEM/RPC 1.6 < η < 2.4
- Extended coverage to  $\eta\simeq 3$

Beam Radiation Instr. and Luminosity, and Common Systems and Infrastructure



#### https://cds.cern.ch/record/2272264

- Si-Strip and Pixels increased granularity
- Design for tracking in L1-Trigger
- Extended coverage to  $\eta\simeq 3.8$

#### **Calorimeter Endcap**

https://cds.cern.ch/record/2293646

- 3D showers and precise timing
- Si, Scint+SiPM in Pb/W-SS

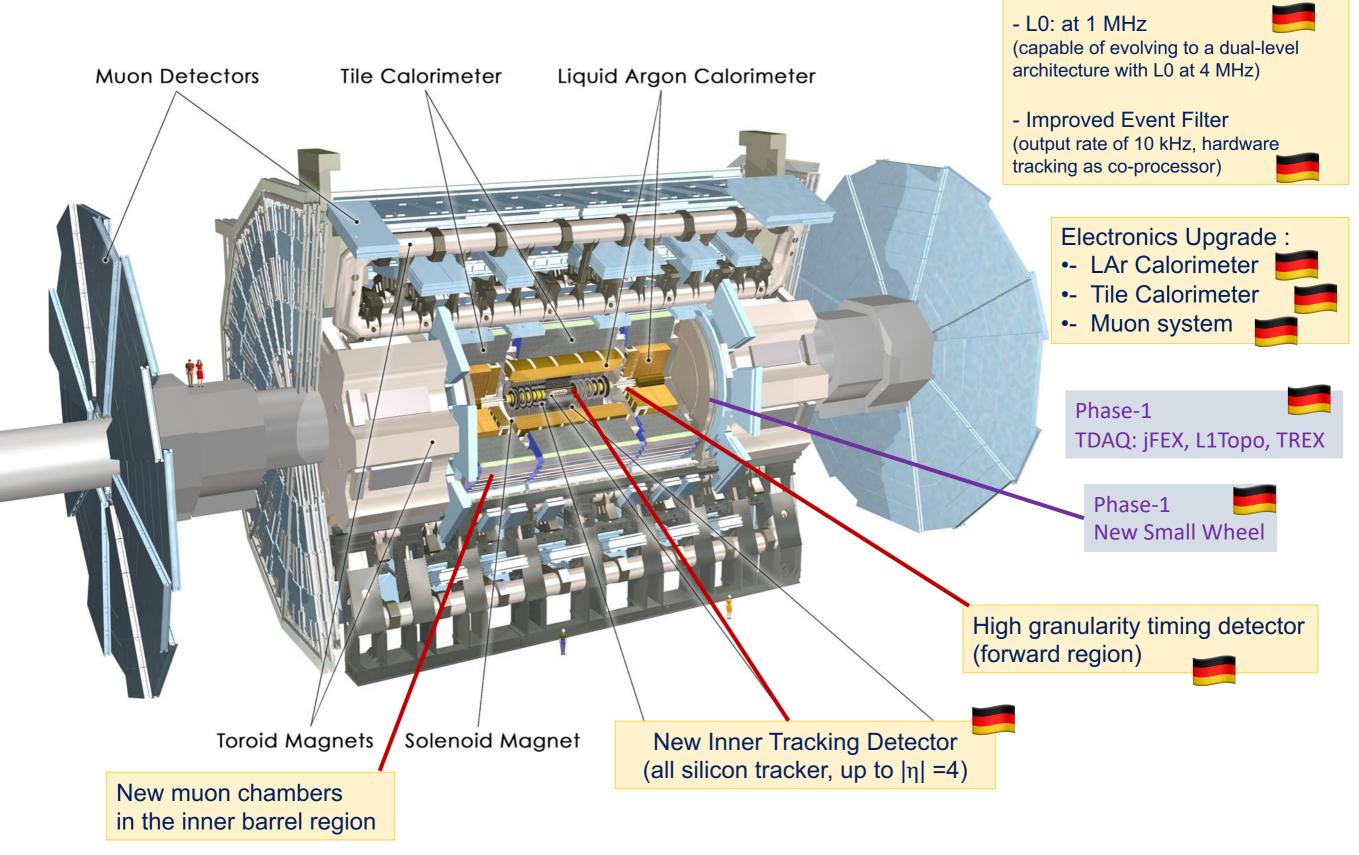
## **MIP Timing Detector**

https://cds.cern.ch/record/2667167

Precision timing with:

- Barrel layer: Crystals + SiPMs
- Endcap layer: Low Gain Avalanche Diodes

# ATLAS – HL-LHC upgrade



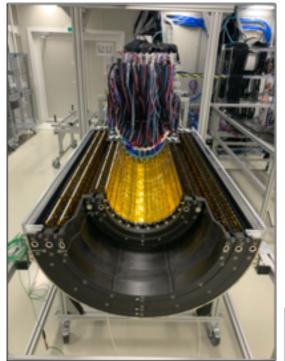
Upgraded Trigger and Data

Acquisition System:



# Highlights ALICE • Inner Tracking System • GENAL C

# The 'big' example of MAPS - ALICE



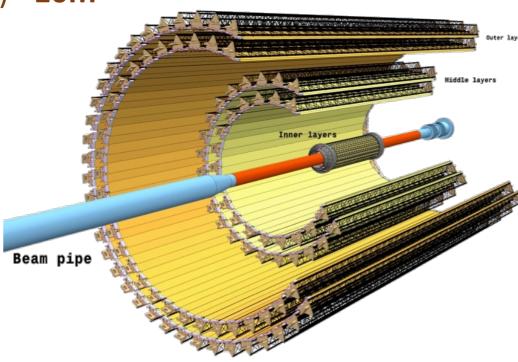
1<sup>st</sup> Ha Barre (Top)

2<sup>nd</sup> Ha Barre (Botte

## LS2: 3+4 layers of MAPS (CMOS) ~10m<sup>2</sup>

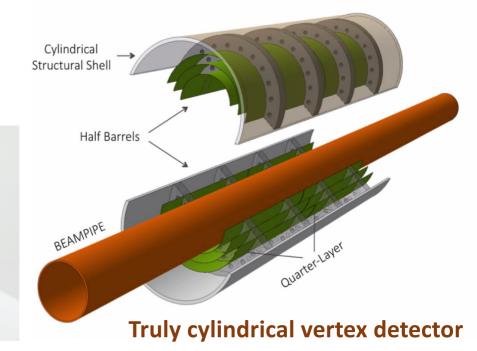
- 27x29  $\mu$ m<sup>2</sup> pixels **12.5 G-pixels**
- MAPS thinned to 50  $\mu m$ 
  - ~0.3 %  $X_0$  per layer
- Radial coverage R= 21 400 mm

E .								
		Inner Barrel			Outer Barrel			
		Layer 0	Layer 1	Layer 2	Layer 3	Layer 4	Layer 5	Layer 6
alf- el )	Half-layer assembly	Done	Done	Done	Done	Done	Done	Done
	Half-barrel assembly	Done	Done	Done	Done	Done	Done	Done
alf- el tom)	Half-layer assembly	Done	Done	Done	Done	Done	Done	Done
	Half-barrel assembly	Done	Done	Done	Week 48	Week 46	Done	Done



## • Future: ALICE upgrade (ITS3) – HR/HV CMOS

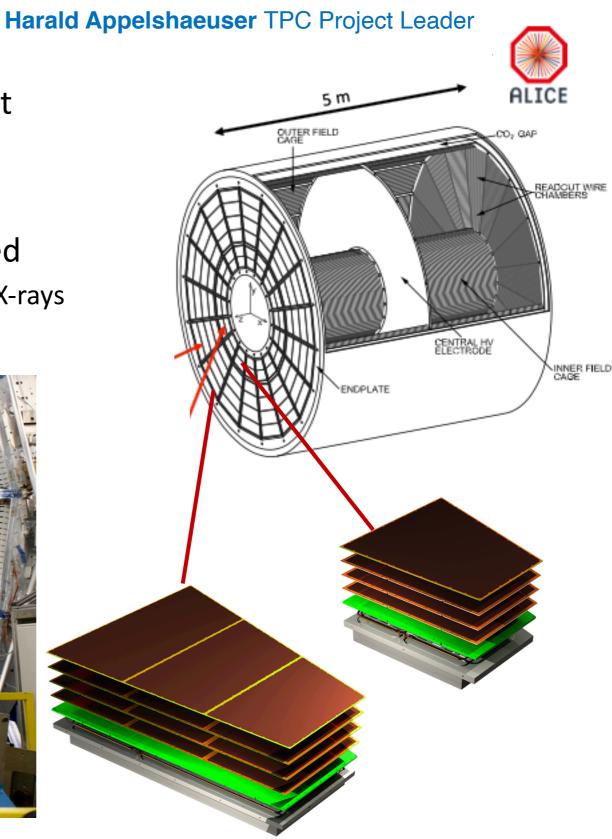
- Push technology further: thinner, large sensors through stitching
- Faster signal, more radiation hard
- Pixel sizes  $10x10\mu m^2 \rightarrow 3\mu m$  position resolution
- X/X0 per layer 0.05%
- CURVED



# ALICE TPC Read out chambers – LS2

- Replace MWPC-base readout chambers and FE electronics in LS2 to allow **continuous readou**t of Pb-Pb collisions at 50kHz in Run-3 and Run-4
  - 4-layer GEM detectors
- Installation of GEMs and FE electronics completed
  - Next: pre-commissioning with laser, cosmics, pulser, X-rays





Plus German coordination (V. Lindenstruth) of Event Processing Nodes (EPN – GPU farm) within the O<sup>2</sup> project, important to calibrate (among others) the enormous TPC data



# ATLAS

#### Highlights

- Phase-1
- Inner Tracking System
- Electronics
- High Granular Timing Detector

# ATLAS Phase-1

- (i) LAr Trigger Electronics upgrade
  - enhance granularity at trigger level



Required speed achieved in routine operations to remove/install electronics

**On Track** 

## • (ii) Trigger / DAQ



Take full advantage of the LAr trigger electronics upgrade and improved end cap muon trigger (NSW)

## • (iii) Muon System: New Small Wheel

- Replace inner muon station in the endcap
   → reduced muon fake trigger rate, preserve position resolution and efficiency at HL-LHC
  - Micromegas MM
     & Thin Gap Chambers (sTGC)

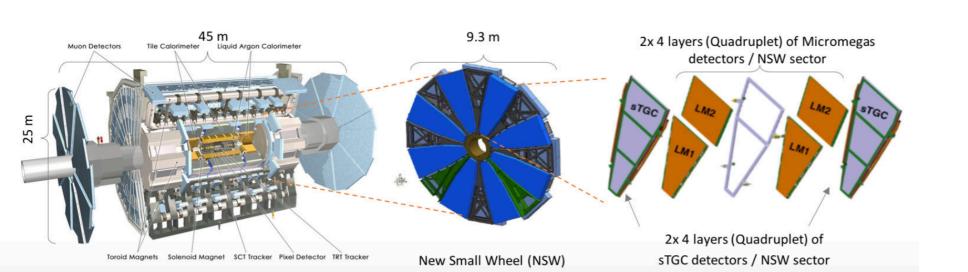


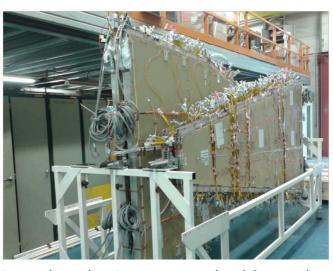
Schedule consistent with LS2 installation and commissioning plans

#### **On Track**

#### S. Zimmermann - Upgrade Project Leader of NSW

Plan to install **NSW-A** in LS2 and NSW-C in a later EYETS Slice Test early Nov. confirms this plan (on critical path)





Completed Micromegas double wedge

## ATLAS Phase-2 Inner Tracker





Barrel strips module with hybrid / ASICs

5 Pixel layer + endcaps4 Strip layers + endcaps (tilted geometry

Strip barrel

## All-Silicon Tracker

- Strips: Final Design reviews of many components passed
  - Sensors, chips, stave and petal bus tapes, modules and their components (hybrids, power boards)

## Largest Pixel Detector ~13m<sup>2</sup>

- Market survey of module hybridization in final stage
  - 200 modules being constructed with RD53A chip
     (→ system tests, test of serial powering and assembly)

Convener Strips I. Bloch: Modules I. Gregor: Integration D. Spärlich

- P. Göttlicher: Local Support Electronics
- n **D. Spärlich:** System Test

#### Convener Pixel

- J. Weingarten: Sensors
- T. Flick: On-detector services
- **F. Huegging:** Hybridization **M. Hamer:** Off-detector services

Quad

A-side dual

Pixel

**Pixel modules** 

Strip endcap

#### Convener H. Kroha: sMDT sub-project coordinator

## ATLAS Phase-2 Muon Spectrometer

## chamber design almost finished

**Inner Barrel sMDT:** 

#### • Inner Barrel RPC:

- Single channel prototype of front-end ASIC produced 👀

#### MDT/sMDT electronics:

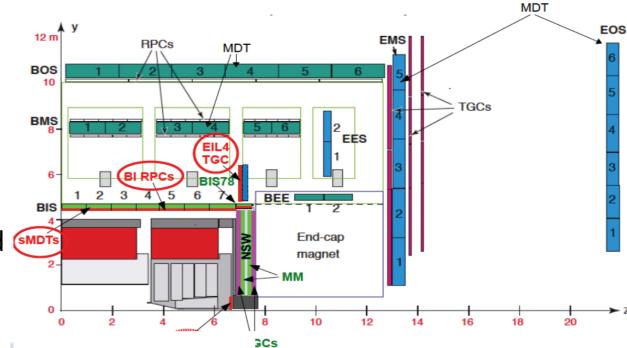
- Amplifier-Shaper-Discriminator ASIC (ASD)

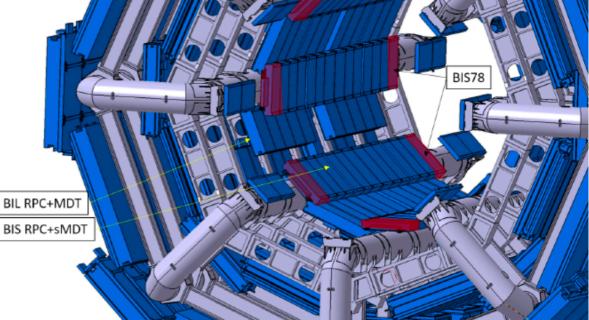
- New TDC ASIC (for MDT drift time)

#### • TGC electronics:

- Patch Panel ASIC entering production (~11'000 ASICs by June 2020)

## All sub-projects are progressing well, without serious issues



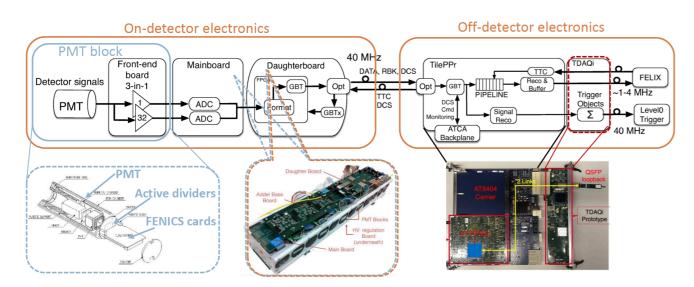


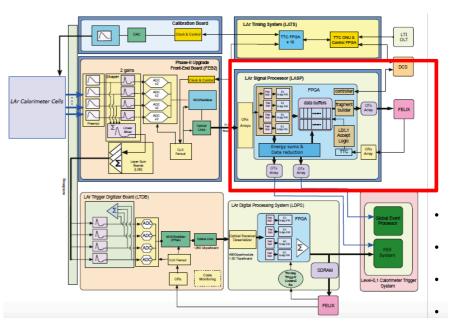
# ATLAS Phase-2 Calorimeter LAr and Tile

• Replace complete front- and back-end electronics



Plus, replace some PMTs of the Tile Calorimeter plus some new mechanics

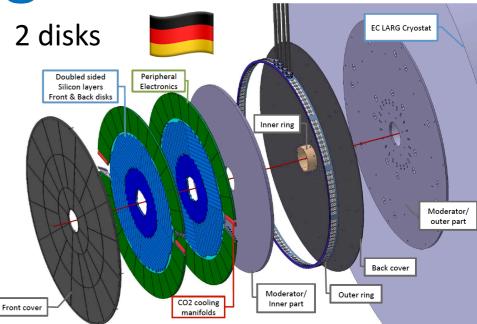




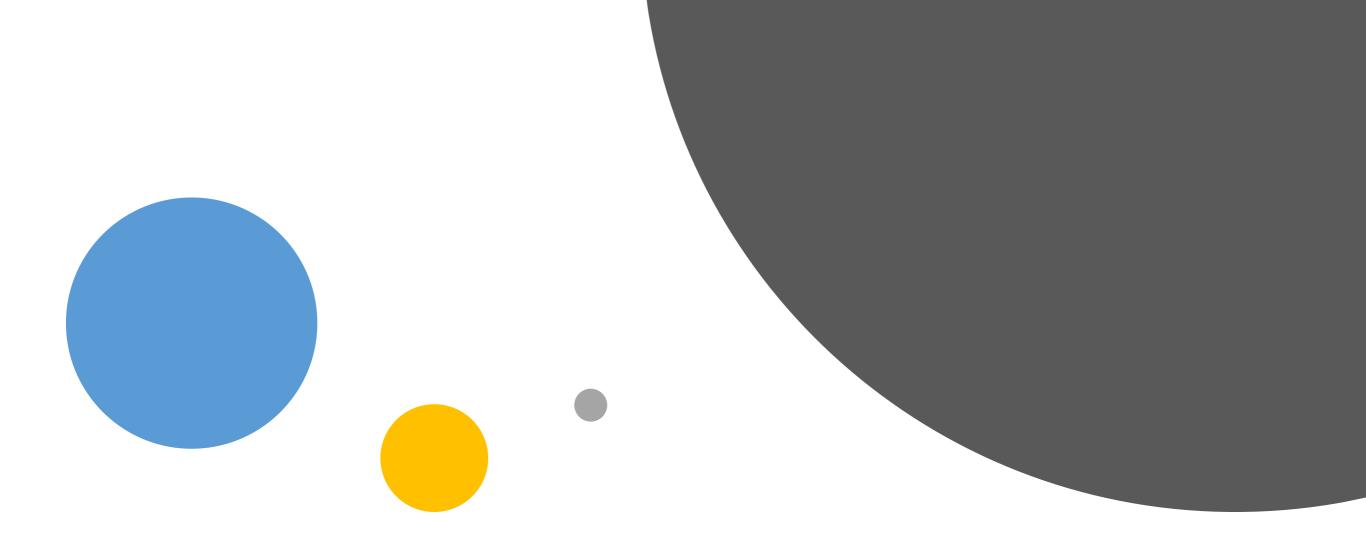
Hans-Christian Schultz-Coulon L1Calo Project Leader

## and High Granularity Timing Detector

- ATLAS HGTD project is very challenging (new technology, major R&D, late start, challenging environment)
- Significant Progress towards submission of TDR in April 2020
- Sensors: LGAD irradiated with neutrons, protons and X-rays.



Convener: L. Masetti: modules



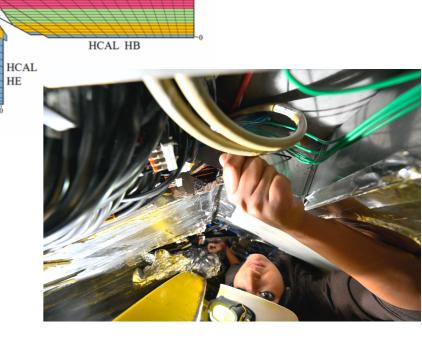
# CMS · Tracker • Muons

Highlights

- High Granularity Calorimeter

# CMS Phase -1 Concluded!

 Hadron Barrel installation finished commissioning including <sup>60</sup>Co scan early Nov.





## • Pixel Layer 1 replacement on track

- New DCDCs for the whole detector
- Layer 1
  - Improved ROC
  - Voltage now up to 800V



14 13 12 11 10 9 8 7 6 5 4 3 2 1

HCAL

HE

Phase-1 upgrade HCAL HB

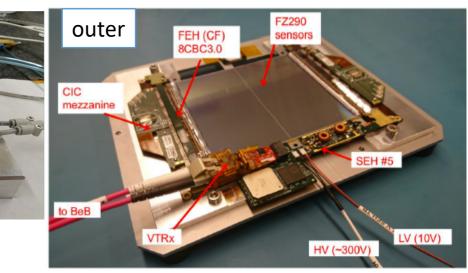
14 13 12 11 10 9 8 7 6 5 4 3 2 1

# CMS Muons Phase-2 📁



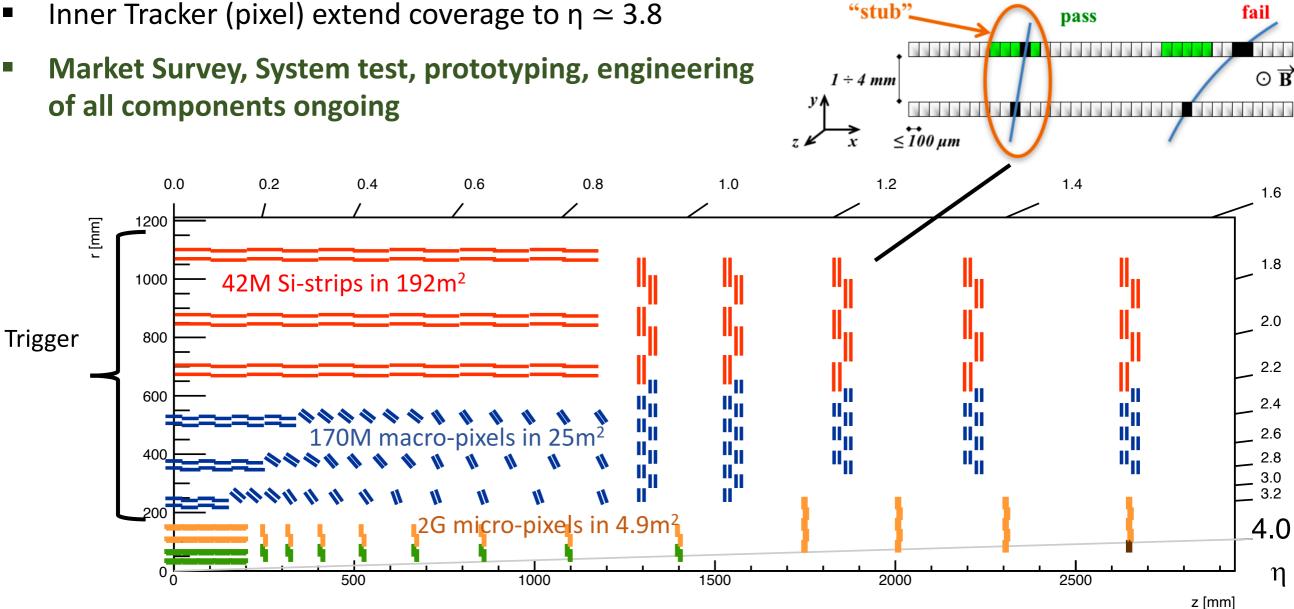
- GEM GE2/1 services
- RPC RE34/1 services

- Outer Tracker design driven by ability to provide **tracks at 40 MHz to L1-trigger** (p<sub>T</sub>>3GeV)
- Tilted modules in three OT layers
- Inner Tracker (pixel) extend coverage to  $\eta \simeq 3.8$
- Market Survey, System test, prototyping, engineering of all components ongoing



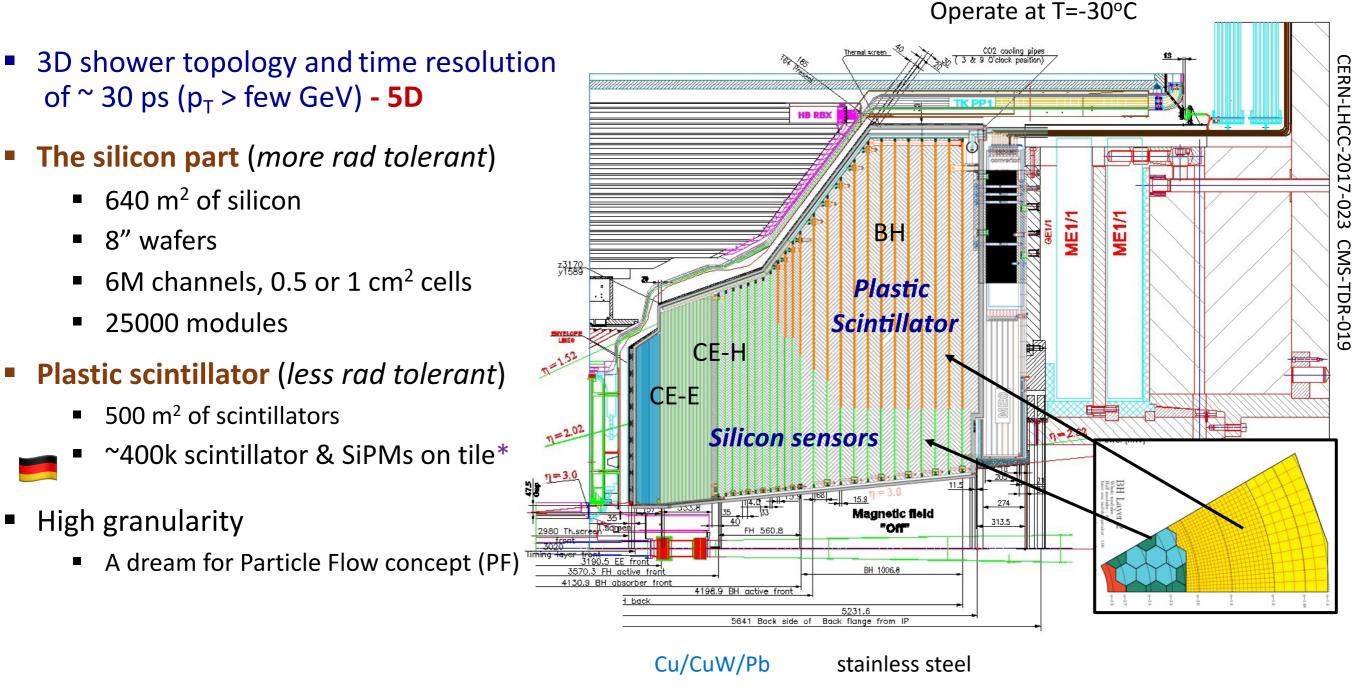
Fully equipped 8CBC3 based 2S module at Aachen

 $(p_T > 3 GeV)$ 



inner

## Silicon enters calorimetry on large scale – LS3



CE-E: **28** sampling layers – 26  $X_o$  + ~1.7  $\lambda$ 

**22** sampling layers –  $8 \lambda$ 

Convener from Germany: **F. Sefkow:** Scintillators and SiPMs

# ATLAS & CMS more highlights

2

# An important milestone - CERN, 23<sup>rd</sup> August 2019:



- Signature of frame contract between CERN and Hamamatsu Photonics on production of silicon sensors for ATLAS and CMS Phase-II
  - ATLAS ITk strips,
  - CMS strip tracker,
  - CMS endcap calorimeter

More than 1000m<sup>2</sup> of silicon



# LHCB

#### Highlights

- SciFi
- Real Time Analysis Project

The march towards the Upgrade-I is continuing

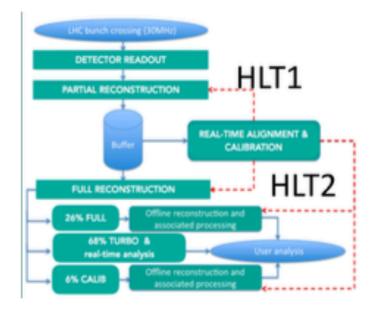
- All subsystems progressing installation ongoing!
- Schedule is tight, working hard to be ready for LHC Run 3!

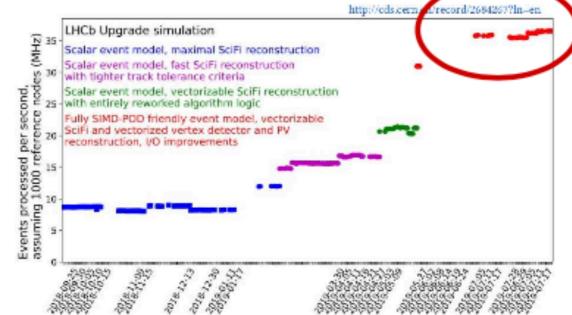
#### S. Hansmann-Menzemer: RTA deputy project leader

# LHCb Real Time Analysis Project (RTA)

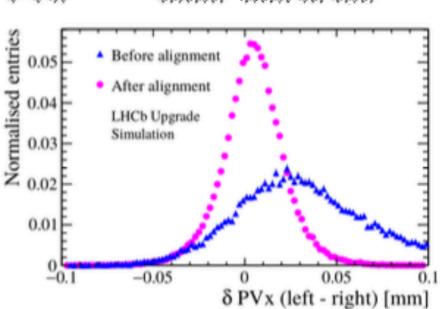


### Baseline CPU-based HLT1 reached throughput > 30 MHz





- physics performance studies ongoing
  - triggering in beam gas mode
    - $\rightarrow$  test full flexibility
  - real time alignment



- Deployment of HLT2 lines started
- In parallel evaluation of accelerators for HLT1 (FPGA clustering, GPU reconstruction, ...)

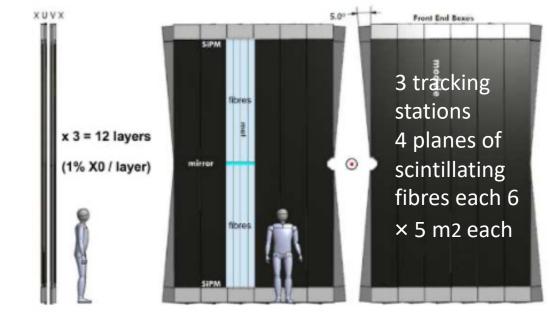
U. Uwer: project coordinator

# LHCb SciFi 📁

Module production & test finished, SiPM tests finished, test of front-end electronic ongoing, main work now: detector frame assembly &

3 (out of 12) C-frames assembled





## Novel detector

- read out by SiPMs, cooled to -40°C
- 1% X<sub>0</sub> per detector plane
- 99% single hit efficiency
- $\sigma_{\chi} < 100 \, \mu m$ 
  - (in test beam  $\sigma x < 70 \mu m$ )

Tight schedule: installation of first 6 C frames scheduled early spring 2020

# Conclusion

- Massive work ongoing at all four LHC sites and it will be even more during LS3
  - Very strong and continuous German contribution!
- These beautiful upgrades will give us even more opportunities to understand the complex events at high pile-up
  - Completely new electronics
  - New Trackers, partially new Muons
  - New DAQ, Trigger
  - Precision timing

- Sorry if I did not fit your favorite detector
- Slides and information mainly from the last RRB and many dear colleagues:
  - Stephanie Menzemer, Stephanie Zimmermann, Volker Buescher, Karl Jakobs, Harald Appelshäuser, Arnulf Quadt, Hans-Christian Schultz-Coulon, Lucia Masetti, Francesco Lanni
- And big thanks to our funding agencies



Bundesministerium für Bildung und Forschung

Forschungsinfrastrukturen (FIS)



MAX-PLANCK-GESELLSCHAFT

# Backup

## Upgrade: UT

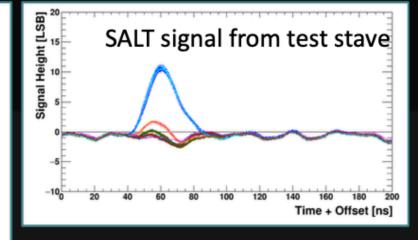
#### SALT3.5

- 18 wafers received in early July  $\star$
- Wafer testing completed in summer  $\star$
- Good yield: ~82 % => ~6850 chips  $\star$
- SALT3.8 (8-chip hybrid version): diced chips at • CERN, ready for final tests
- Hybrids and flex cables being produced  $\bullet$
- Ready to start stave production •
- Readout electronics and mechanics progressing • well
- Tight schedule ! •



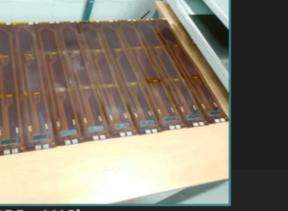


Data flex: Short





G. Passaleva 30



ength ~ 97 mm

512 strips

4 ASICs

½ pitch

1024 strips

8 ASICs

1/2 length

1024 strips

8 ASICs

½ pitch

1/2 length

024 strips

UT slice test

instrumented

stave at CERN

with an

8 ASICs



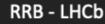
#### 30/10/2019

LHCD

G. Passaleva 32

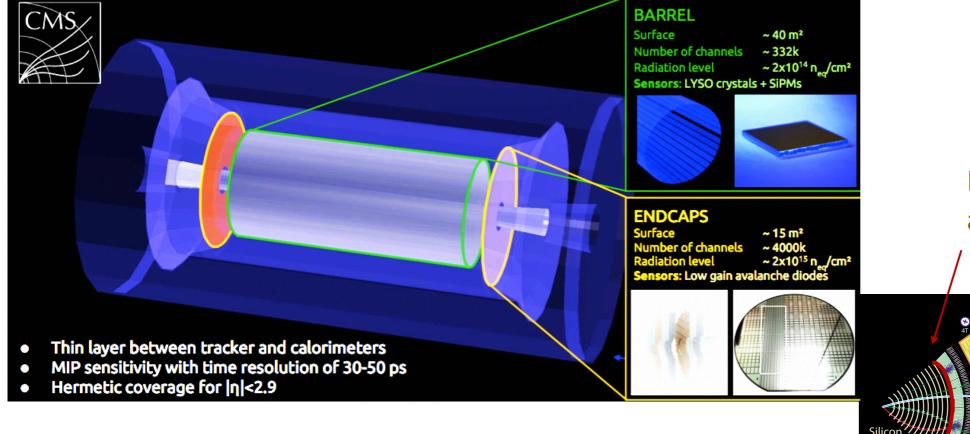
## Upgrade: RICH

- All components for photon detection system at hand
- Readout electronics produced
- Q&A well advanced, components at CERN for "column" assembly
- RICH1 spherical mirrors at CERN for coating
- Mechanics progressing well
- RICH1 MaPMT support chassis and gas enclosure installed.
- Unfortunately problem: the quartz window cracked
  - ★ Need to build a new one
  - ★ Essentially no input on schedule but additional work needed

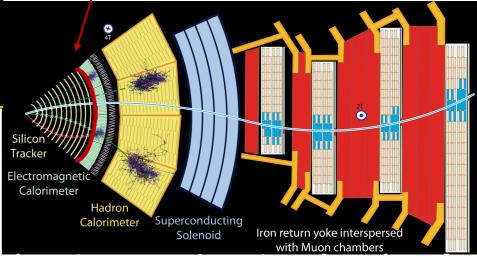






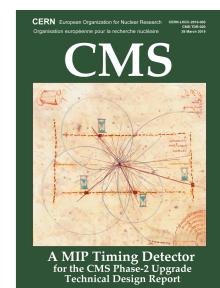


## Between Tracker and Calorimeter



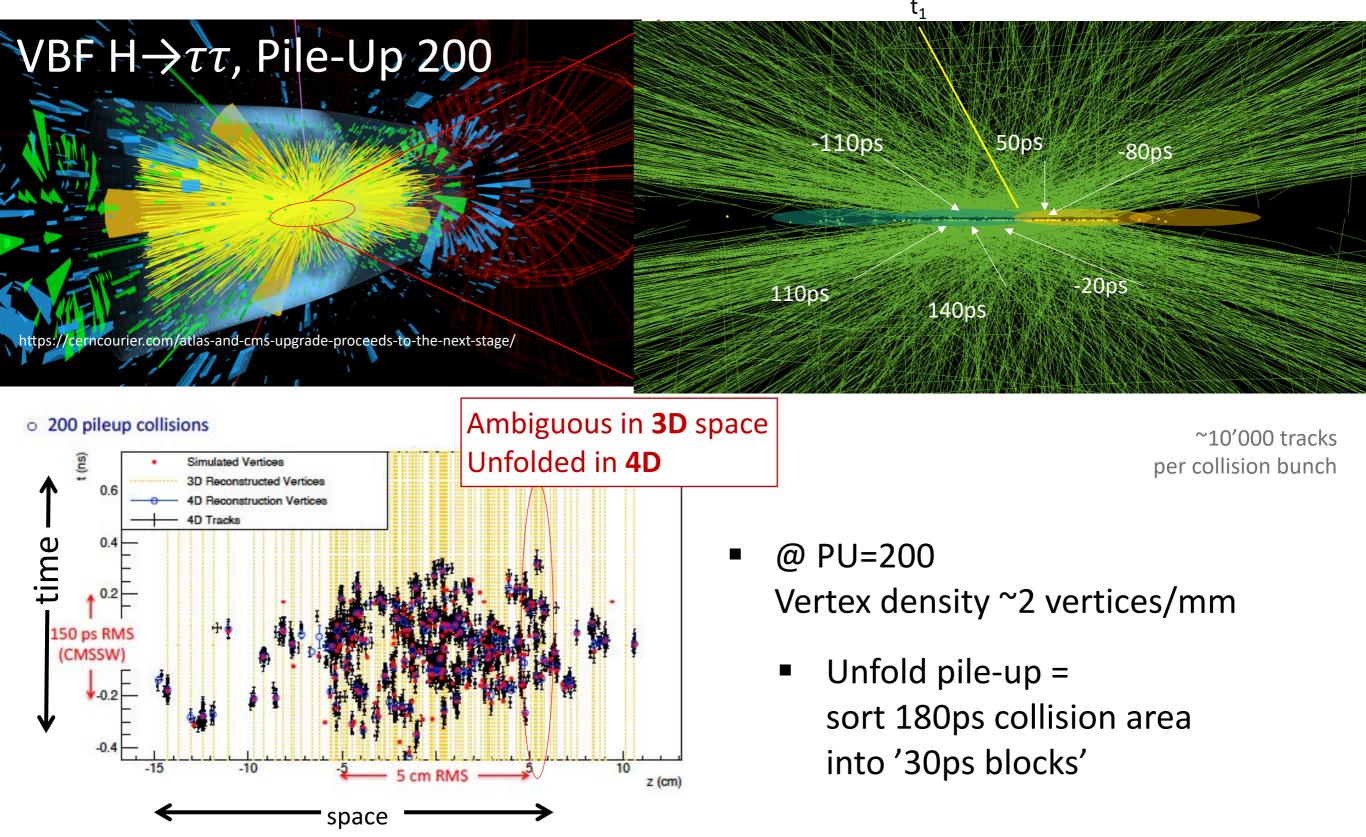
30 ps timing – the extra independent parameter makes the difference

MTD MIP Timing Detector this is new



CERN-LHCC-2019-003 CMS-TDR-020

# Sorting the mess even better



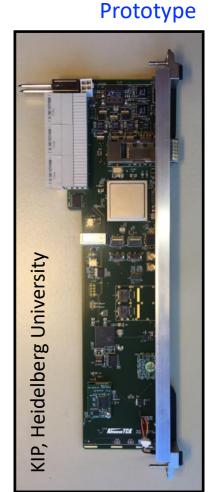
## ATLAS Tile Pre-Processor Upgrade

New electronics for pre-processing Hadron Tile Calorimeter Trigger Data

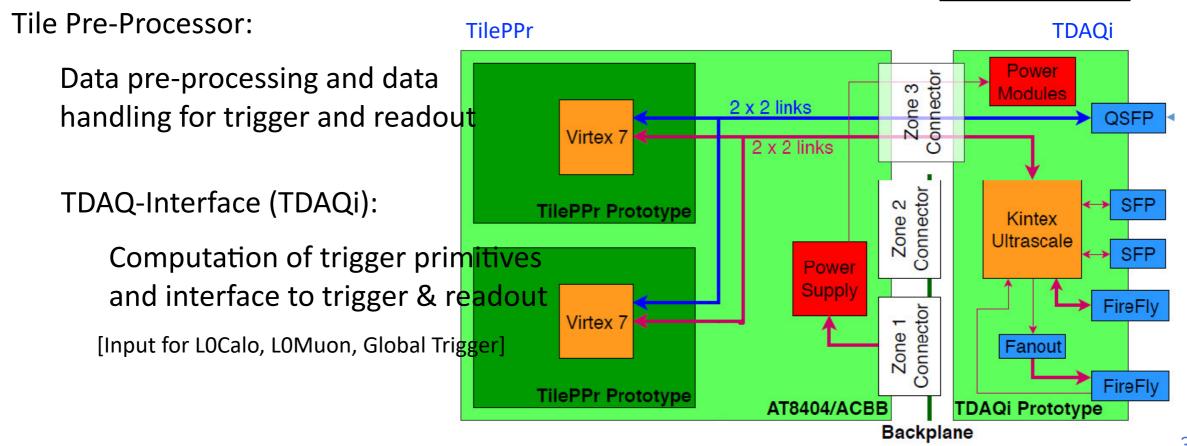
ATLAS Phase-2:

Digitisation of Tile Trigger data at front-end

Provides full cell granularity to trigger Requires new readout and trigger electronics



**TDAQi** 



## Upgrade: VELO

- Production of VELO modules started, although still not at the nominal pace
- Mechanics and readout electronics progressing well
- Important decision to proceed to RF-foil etching: successfully thinned down to 150 µm
- Tight schedule! ۰



VELO etching with NaOH solution Green area is passivated Etched boxes are now at Nikhef for final metrology and coating







30/10/2019

RRB - LHCb

35